

2SK1300 Silicon N Channel MOS FET

REJ03G0919-0200 (Previous: ADE-208-1258) Rev.2.00 Sep 07, 2005

Application

High speed power switching

Features

- Low on-resistance
- High speed switching
- Low drive current
- 4 V gate drive device
- Can be driven from 5 V source
- Suitable for motor drive, DC-DC converter, power switch and solenoid drive

Outline





Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	100	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	ID	10	А
Drain peak current	I _{D(pulse)} *1	40	А
Body to drain diode reverse drain current	I _{DR}	10	А
Channel dissipation	Pch ^{*2}	40	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1%

2. Value at $T_C = 25^{\circ}C$

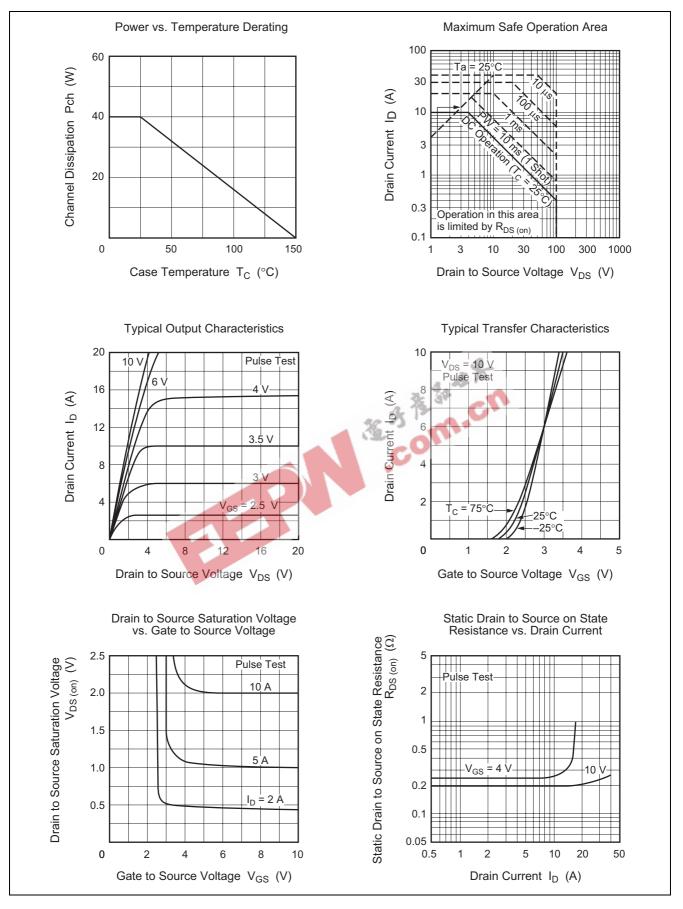
Electrical Characteristics

						$(Ta = 25^{\circ}C)$
ltem	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	V _{(BR)DSS}	100	—	—	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V _{(BR)GSS}	±20	—	—	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	—	—	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	—	—	250	μΑ	$V_{DS} = 80 V, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	1.0	—	2.0	V	I _D = 1 mA, V _{DS} = 10 V
Static drain to source on state	R _{DS(on)}	—	0.20	0.25	Ω	$I_D = 5 \text{ A}, \text{ V}_{GS} = 10 \text{ V}^{*3}$
resistance		_	0.25	0.35	Ω	$I_D = 5 \text{ A}, V_{GS} = 4 \text{ V}^{*3}$
Forward transfer admittance	y _{fs}	4.5	7.0	~ 0 ''	S	$I_D = 5 \text{ A}, V_{DS} = 10 \text{ V}^{*3}$
Input capacitance	Ciss	-	5 25		рF	$V_{DS} = 10 V, V_{GS} = 0,$
Output capacitance	Coss	H	205	_	рF	f = 1 MHz
Reverse transfer capacitance	Crss	4	60	—	рF	
Turn-on delay time	t _{d(on)}		5	—	ns	$I_D = 5 \text{ A}, V_{GS} = 10 \text{ V},$
Rise time	tr	_	50	—	ns	$R_L = 6 \Omega$
Turn-off delay time	t _{d(off)}	—	170	—	ns	
Fall time	t _f	_	75	—	ns	
Body to drain diode forward voltage	V _{DF}	—	1.2	—	V	$I_F = 10 \text{ A}, V_{GS} = 0$
Body to drain diode reverse recovery	t _{rr}	—	220	—	ns	$I_F = 10 \text{ A}, V_{GS} = 0,$
time						di _F /dt = 50 A/µs

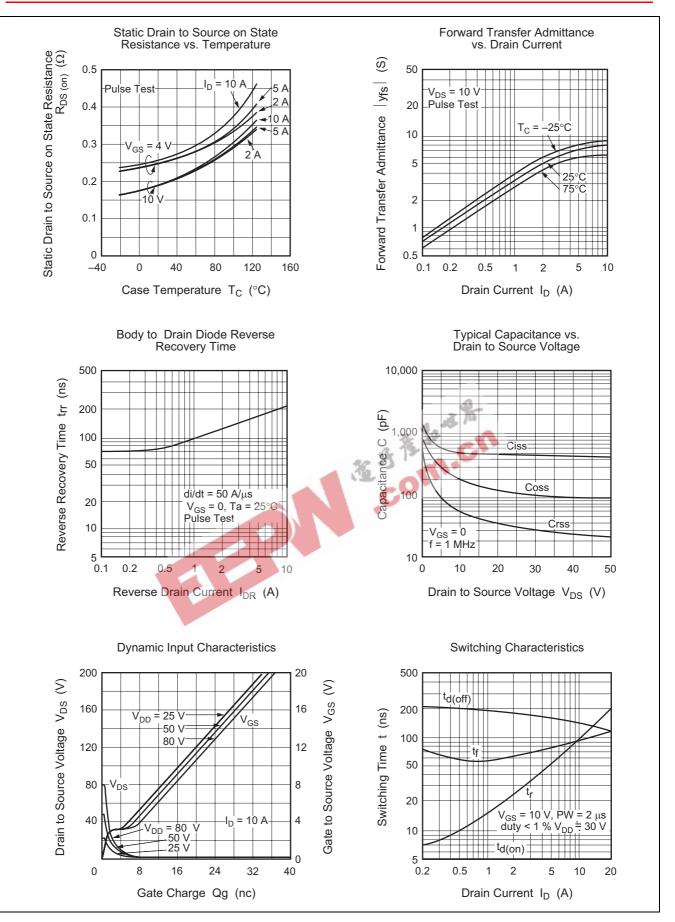
Note: 3. Pulse test



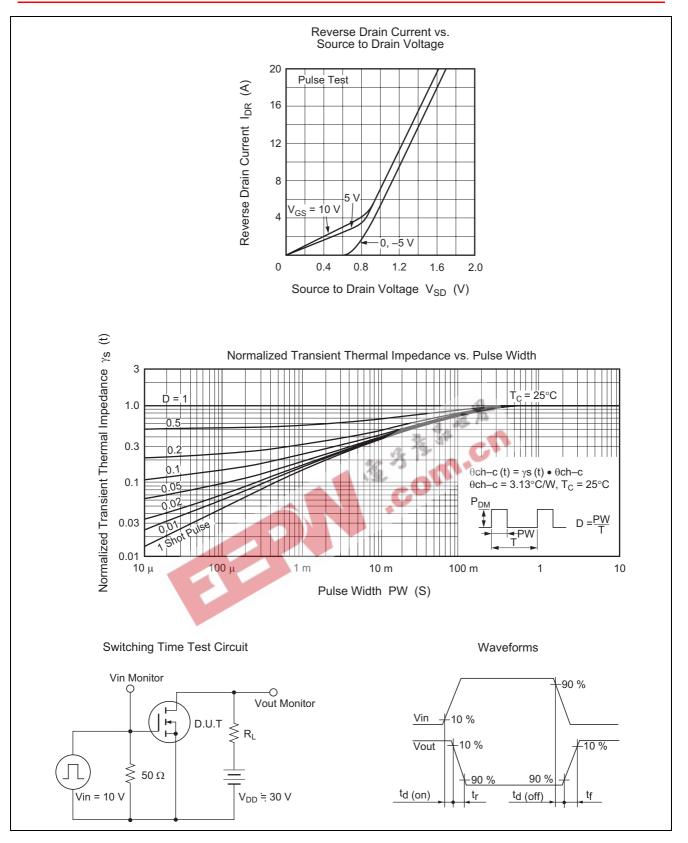
Main Characteristics





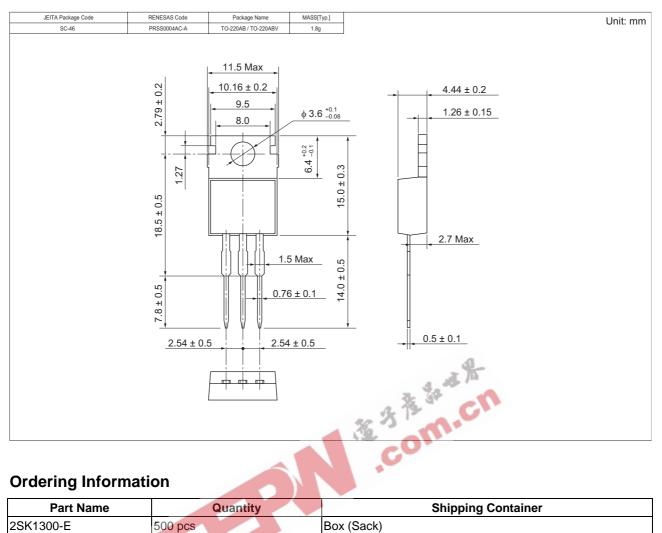






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Package Dimensions



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